IN THE CLAIMS:

Cancel claim 3.

Amend claims 1 and 9 as set forth below:

- 1. (currently amended) A system for precisely controlling an amount of flatness or curvature of a lapping plate, the system comprising:
 - a rotatable platform;
 - a lapping plate mounted to the rotatable platform for rotation therewith;
 - a holder having a workpiece located between the holder and the lapping plate;
 - an abrasive slurry located between the lapping plate and the workpiece;
- means for controlling a temperature of the lapping plate and thereby precisely manipulating an amount of flatness or curvature of the lapping plate; and wherein

the temperature of the lapping plate is adjusted during a charge process to selectively charge different areas of the lapping plate in a dictated order and the workpiece is a magnetic slider.

- 2. (original) The system of claim 1, wherein a bimetallic effect is exploited to induce a linear expansion in the lapping plate so that the flatness or curvature of the lapping plate is manipulated with thermal cycling.
- 3. (canceled)
- 4. (original) The system of claim 1, wherein the lapping plate can be configured in a flat, concave, or convex shape.
- 5. (original) The system of claim 1, wherein the lapping plate gives the workpiece a high crown-to-camber ratio.
- 6. (canceled)

- (previously presented) The system of claim 1, wherein a middle diameter portion of the 7. lapping plate is charged first, and then an inner diameter portion of the lapping plate and/or an outer diameter portion of the lapping plate.
- (original) The system of claim 1, wherein a temperature of the workpiece and the 8. abrasive slurry are controlled along with the temperature of the lapping plate.
- (currently amended) [[The system of claim 1, wherein]] A system for precisely controlling an amount of flatness or curvature of a lapping plate, the system comprising:

a rotatable platform;

a lapping plate mounted to the rotatable platform for rotation therewith;

a holder having a workpiece located between the holder and the lapping plate;

an abrasive slurry located between the lapping plate and the workpiece;

means for controlling a temperature of the lapping plate and thereby precisely manipulating an amount of flatness or curvature of the lapping plate; and wherein

the temperature of the lapping plate is adjusted during a charge process to selectively charge different areas of the lapping plate in a dictated order, and the lapping plate is formed from a plurality of layers of materials having different coefficients of linear expansion.

- (original) The system of claim 9, wherein the layers are formed from metal alloys. 10.
- (original) The system of claim 10, wherein the layers comprise a tin-antimony alloy 11. adjacent to the workpiece, and a steel alloy base.
- (original) The system of claim 1, wherein the lapping plate comprises a material with a 12. linear expansion coefficient of 23-x-10⁻⁶/°C bonded to another material with a linear expansion coefficient of 10-x-10-6/°C.
- (original) The system of claim 1, wherein the lapping plate gives the workpiece a 13. negative crown and positive camber values.

- (canceled) 14.
- (canceled) 15.
- (canceled) 16.
- (canceled) 17.
- (previously presented) The system of claim 1, wherein the means for controlling temperature comprises a temperature regulating unit that circulates fluid that travels between a thermal bath and a chuck holding the lapping plate.
- (previously presented) The system of claim 1, wherein an interior air temperature of a 19. facing tool is also regulated during facing of the lapping plate.
- (previously presented) A system for precisely controlling an amount of flatness or 20. curvature of a lapping plate, the system comprising:
 - a rotatable platform;
- a lapping plate mounted to the rotatable platform for rotation therewith, the lapping plate being formed from a plurality of layers of metal alloy materials having different coefficients of linear expansion;
 - a holder having a magnetic slider located between the holder and the lapping plate; an abrasive slurry located between the lapping plate and the magnetic slider;
- means for controlling a temperature of the lapping plate, the magnetic slider, and the abrasive slurry, the means comprising a temperature regulating unit that circulates fluid that travels between a thermal bath and a chuck holding the lapping plate, and thereby precisely manipulating an amount of flatness or curvature of the lapping plate, such that a bimetallic effect is exploited to induce a linear expansion in the lapping plate so that the flatness or curvature of the lapping plate is manipulated with thermal cycling; wherein

the temperature of the lapping plate is adjusted during a charge process to selectively charge different areas of the lapping plate in a dictated order, and give the magnetic slider a high crown-to-camber ratio; and wherein

a middle diameter portion of the lapping plate is charged first, and then an inner diameter portion of the lapping plate and an outer diameter portion of the lapping plate.

- 21. (previously presented) The system of claim 20, wherein the lapping plate can be configured in a flat, concave, or convex shape.
- 22. (previously presented) The system of claim 20, wherein the layers comprise a tinantimony alloy adjacent to the magnetic slider, and a steel alloy base.
- 23. (previously presented) The system of claim 20, wherein the lapping plate comprises a material with a linear expansion coefficient of 23-x-10⁻⁶/°C bonded to another material with a linear expansion coefficient of 10-x-10⁻⁶/°C.
- 24. (previously presented) The system of claim 20, wherein an interior air temperature of a facing tool is also regulated during facing of the lapping plate.